Interference

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	5829	((pad$6 or bondpad or metallurgy) and (wirebond$6 or ((wire or wiring) near5 bond$6))).clm.	US-PGPUB; USPAT	OR	ON	2005/10/21 14:49
L3	425	2 and ((Au or gold) and (Ni or nickel)).clm.	US-PGPUB; USPAT	OR	ON	2005/10/21 14:50
L4	26	3 and (Ta or tantalum or Ta?TaN or TaN?Ta).clm.	US-PGPUB; USPAT	OR	ON	2005/10/21 14:50
L5	11	4 and (TaN or ((tantalum or Ta) adj nitride)or Ta?TaN or TaN?Ta).clm.	US-PGPUB; USPAT	OR	ON	2005/10/21 14:51

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	6316	(pad$6 or bondpad or UBM or metallurgy) and (Ni or nickel) and (Au or gold) and (Ta or Tantalum or TaN or Ta?TaN or TaN?Ta)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 10:36
L2	5744	1 and (@ad<"20030918" or @rlad<"20030918")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 10:31
L3	1353	2 and ((wire or wiring) near5 bond$6 or wirebond$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 10:32
L4	1245	3 and (opening or via or hole or trench or groove or aperture)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 10:33
L5	1115	4 and (chip or die or IC or semicondutor or (integrated adj circuit))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 10:33
L6	930	5 and ((pad$6 or bondpad or UBM or metallurgy or Ni or nickel or Au or gold or Ta or Tantalum or TaN or Ta?TaN or TaN?Ta) same (opening or via or hole or trench or groove or aperture))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 10:34